Technical Data Sheet

1206 Package Chip LED with Inner lens

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow
- solder process.
 - Mono-color type.
 - Pb-free.
 - The product itself will remain within RoHS complaint version.

Descriptions

- The 11-21 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

		Chip		
Part No.	Material	Emitted Color	Lens Color	
11-21/BHC-AP2R1/2T	InGaN	Blue	Water Clear	

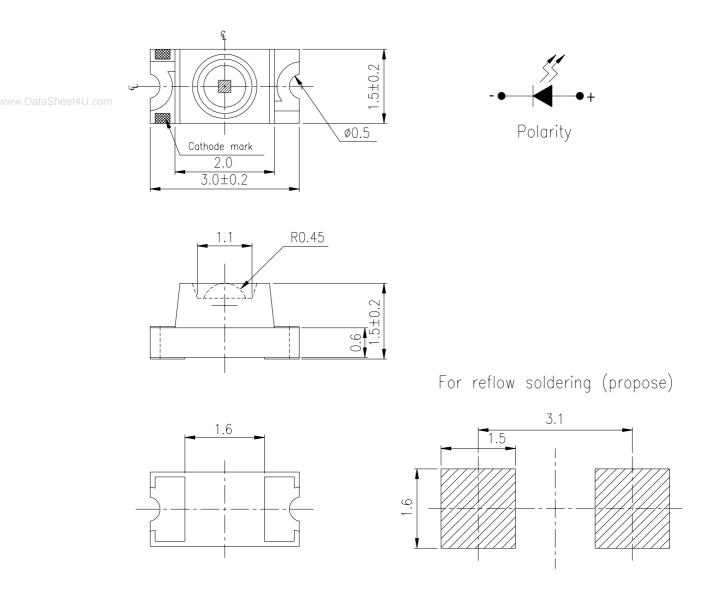


11-21/BHC-AP2R1/2T



11-21/BHC-AP2R1/2T

Package Outline Dimensions



Notes: The tolerances unless mentioned are ± 0.1 , unit=mm.

http://www.everlight.com Prepared date: 17-Aug-2005

11-21/BHC-AP2R1/2T

Absolute Maximum Rat	ings (Ta=2	25℃)		
Parameter	Symbol	Rating	Unit	
Reverse Voltage	VR	5	V	
Forward Current	IF	25	mA	
aSheat4U Operating Temperature	Topr	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +90	°C	
Electrostatic Discharge(HBM)	ESD	150	v	
Power Dissipation	Pd	110	mW	
Peak Forward Current (Duty 1/10 @1KHz)	IFP	100	mA	
Soldering Temperature	Tsol	C	: 260 ℃ for 10 sec. 350 ℃ for 3 sec.	

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Luminous Intensity	Iv	57		140	mcd		
Viewing Angle	$2 \theta 1/2$		60		deg		
Peak Wavelength	λp		468		nm		
Dominant Wavelength	λd	464.5		476.5	nm	IF =20mA	
Spectrum Radiation Bandwidth	$ riangle \lambda$		35		nm		
Forward Voltage	VF	2.7	3.3	3.7	V		
Reverse Current	Ir			50	μA	$V_R = 5V$	

Notes:

1.Tolerance of Luminous Intensity: ±10% 2.Tolerance of Dominant Wavelength: ±1nm

http://www.everlight.com Prepared date: 17-Aug-2005

11-21/BHC-AP2R1/2T

	Group	Bin	Min	Max	Unit	Condition	
		A9	464.5	467.5			
	٨	A10	467.5	470.5		I 20 A	
Sheet4	U.com A	A11	470.5	473.5	nm	IF =20mA	
		A12	473.5	476.5			

Bin Range Of Dom. Wavelength

Bin Range Of Luminous Intensity

0				
Bin	Min	Max	Unit	Condition
P2	57	72		
Q1	72	90		IF =20mA
Q2	90	112	mcd	
R1	112	140		

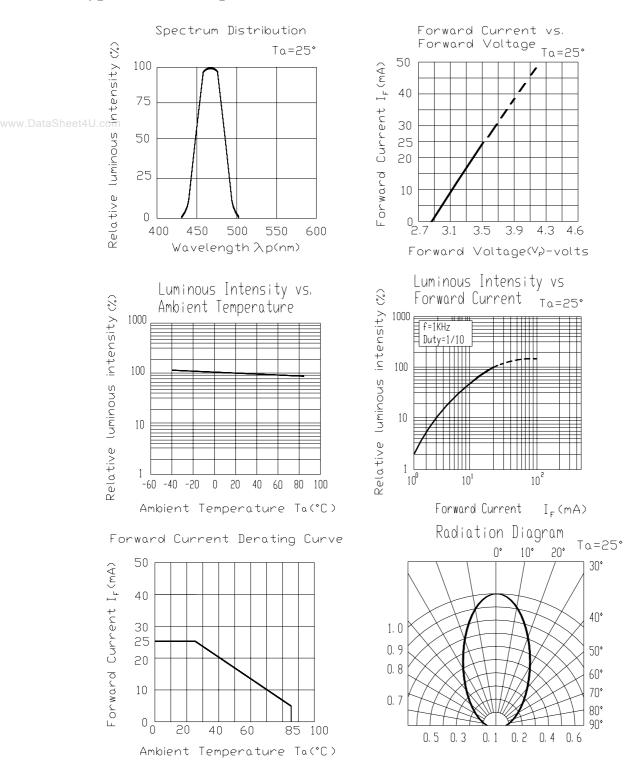
Notes:

1.Tolerance of Luminous Intensity: ±10%

2.Tolerance of Dominant Wavelength: ±1nm

EVERLIGHT ELECTRONICS CO., LTD.

11-21/BHC-AP2R1/2T



Typical Electro-Optical Characteristics Curves

ÆRLIGHT

Everlight Electronics Co., Ltd. Device No:SZDSE-111-B03 http://www.everlight.com Prepared date: 17-Aug-2005 Rev. 2 Page: 5 of 10 Prepared by: Meng Yali www.DataSheet4U.com

11-21/BHC-AP2R1/2T

Label explanation

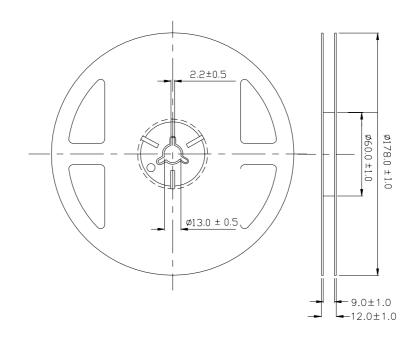
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

^{.DataSheet4U.c}REF: Forward Voltage Rank



Reel Dimensions

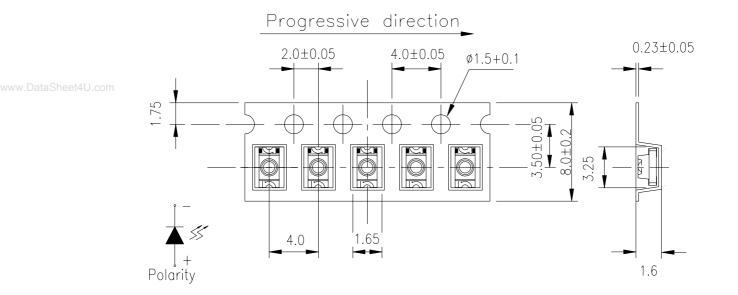


Note: The tolerances unless mentioned are ± 0.1 , Unit = mm.

http://www.everlight.com Prepared date: 17-Aug-2005

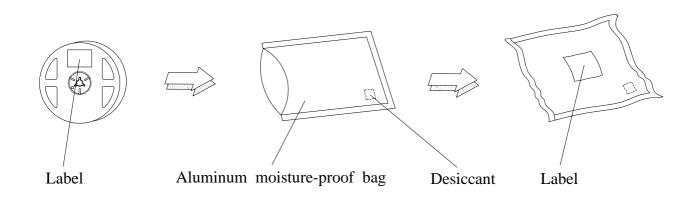
11-21/BHC-AP2R1/2T

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned are ± 0.1 , Unit = mm.

Moisture Resistant Packaging



11-21/BHC-AP2R1/2T

Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level : 90 %

LTPD : 10 %

Detrole	No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
DataShee	1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
	2	Temperature Cycle	H: +100°C 15min $\int 5 \min$ L: -40°C 15min	300 Cycles	22 PCS.	0/1
	3	Thermal Shock	H: +100°C 5min $\int 10 \sec$ L: -10°C 5min	300 Cycles	22 PCS.	0/1
	4	High Temperature Storage	Temp . : 100℃	1000 Hrs.	22 PCS.	0/1
	5	Low Temperature Storage	Temp. : -40°℃	1000 Hrs.	22 PCS.	0/1
	6	DC Operating Life	IF = 20 mA	1000 Hrs.	22 PCS.	0/1
	7	High Temperature / High Humidity	85°C/85%RH	1000 Hrs.	22 PCS.	0/1

11-21/BHC-AP2R1/2T

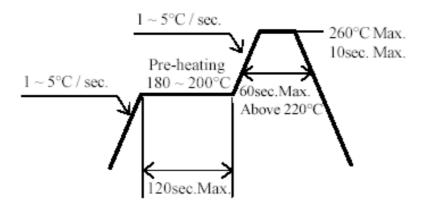
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.(To fit the MSL-2.)
- 2.4 After opening the package, the LEDs should be kept at 30° C or less and 60%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

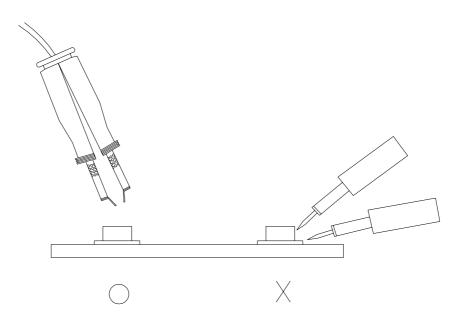
11-21/BHC-AP2R1/2T

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD. Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C

Tel: 886-2-2267-2000, 2267-9936 Fax: 886-2267-6244, 2267-6189, 2267-6306 http://www.everlight.com

Everlight Electronics Co., Ltd. Device No:SZDSE-111-B03 http://www.everlight.com

Prepared date: 17-Aug-2005

Rev. 2Page: 10 of 10Prepared by: Meng Yali

www.DataSheet4U.com